BUT211X

#### **GENERAL DESCRIPTION**

Enhanced performance, new generation, high speed switching npn transistor in a plastic full-pack envelope specially suited for high frequency electronic lighting ballast applications.

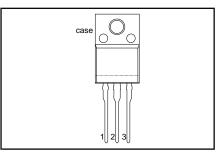
## **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V <sub>CESM</sub>	Collector-emitter voltage peak value	$V_{BF} = 0 \text{ V}$	-	850	V
V <sub>CEO</sub>	Collector-emitter voltage (open base)		-	400	V
I <sub>C</sub>	Collector current (DC)		-	5	Α
1 1*	Collector current peak value		-	10	Α
P <sub>tot</sub>	Total power dissipation	$T_{hs} \le 25  ^{\circ}C$	-	32	W
V <sub>CEsat</sub>	Collector-emitter saturation voltage	$I_{\rm C} = 3.0  \text{A};  I_{\rm B} = 0.4  \text{A}$	-	2.0	V
t <sub>f</sub>	Inductive fall time	$I_{Con} = 3.0 \text{ A}; I_{Bon} = 0.3 \text{ A}$	-	0.1	μs

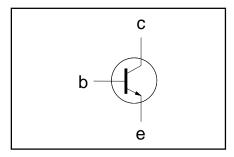
#### **PINNING - SOT186A**

PIN	DESCRIPTION	
1	base	
2	collector	
3	emitter	
case	isolated	

## **PIN CONFIGURATION**



## **SYMBOL**



## **LIMITING VALUES**

Limiting values in accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CESM</sub>	Collector-emitter voltage peak value	$V_{BE} = 0 V$	-	850	V
$V_{CEO}$	Collector-emitter voltage (open base)		-	400	V
I <sub>C</sub>	Collector current (DC)		-	5	Α
I <sub>CM</sub>	Collector current peak value		-	10	Α
I <sub>B</sub>	Base current (DC)		-	2	Α
I <sub>BM</sub>	Base current peak value		-	4	Α
P <sub>tot</sub>	Total power dissipation	$T_{hs} \leq 25  ^{\circ}C$	-	32	W
T <sub>stq</sub>	Storage temperature	113	-65	150	°C
T <sub>j</sub>	Junction temperature		-	150	°C

## THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
R <sub>th j-hs</sub>	Junction to heat sink		-	3.95	K/W
R <sub>th i-a</sub>	Junction to ambient	in free air	-	55	K/W

BUT211X

#### **ISOLATION LIMITING VALUE & CHARACTERISTIC**

 $T_{hs}$  = 25 °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>isol</sub>	R.M.S. isolation voltage from all three terminals to external heatsink	f = 50-60 Hz; sinusoidal waveform; R.H. ≤ 65%; clean and dustfree	. 1		2500	V
C <sub>isol</sub>	Capacitance from T2 to external heatsink	f = 1 MHz	1	10	-	pF

## STATIC CHARACTERISTICS

T<sub>hs</sub> = 25 °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I <sub>CES</sub>	Collector cut-off current <sup>1</sup>	$V_{BE} = 0 \text{ V}; V_{CE} = V_{CESMmax}$ $V_{BE} = 0 \text{ V}; V_{CE} = V_{CESMmax};$ $T_i = 125 \text{ °C}$	-	-	1.0 2.0	mA mA
I <sub>EBO</sub> V <sub>CEOsust</sub> V <sub>CESat</sub> V <sub>BEsat</sub> h <sub>FE</sub> h <sub>FE</sub>	Emitter cut-off current Collector-emitter sustaining voltage Collector-emitter saturation voltage Base-emitter saturation voltage DC current gain	$V_{EB} = 9.0 \text{ V}; I_{C} = 0 \text{ A}$ $I_{B} = 0 \text{ A}; I_{C} = 100 \text{ mA};$ $L = 25 \text{ mH}$	- 400 - - 13 7.5	- - 0.8 - 21 11	10.0 - 2.0 1.3 30 -	mA V V V
h <sub>FE</sub>	Gain bands <sup>2</sup> 1 (Acceptance limits) 2		13 18 23	- - -	20 25 30	

#### **DYNAMIC CHARACTERISTICS**

T<sub>hs</sub> = 25 °C unless otherwise specified

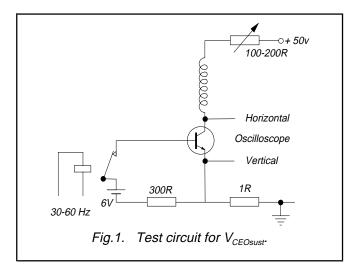
SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
t <sub>s</sub>	Switching times resistive load Turn-off storage time Turn-off fall time	$I_{Con} = 3.0 \text{ A}; I_{Bon} = 0.3 \text{ A}; -I_{Boff} = 0.6 \text{ A}$	1.5 0.5	2.0 0.8	μs μs
	Switching times inductive load	$I_{Con} = 3.0 \text{ A}; I_{Bon} = 0.3 \text{ A}; L_{B} = 1 \mu\text{H}; $ - $V_{BB} = 5 \text{ V}$			
t <sub>s</sub>	Turn-off storage time Turn-off fall time		1.0 60	1.2 100	μs ns
		$I_{Con} = 3.0 \text{ A}; I_{Bon} = 0.3 \text{ A}; L_{B} = 1 \mu\text{H}; -V_{BB} = 5 \text{ V}; T_{i} = 100 ^{\circ}\text{C}$			
$t_s$ $t_f$	Turn-off storage time Turn-off fall time	,	1.1 120	1.4 250	μs ns

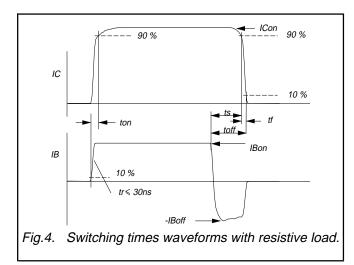
Product is divided into 3 gain bands for matching purposes. The gain band is printed on the device. All devices within a device rail will be from the same gain band. However, a box may contain rails from more than one band. Band quantities are shown on the box label. It is not possible to order specific gain bands.

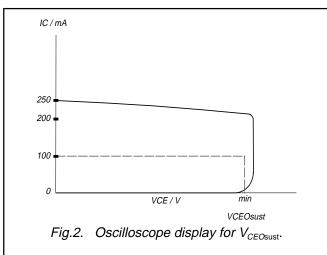
<sup>1</sup> Measured with half sine-wave voltage (curve tracer).

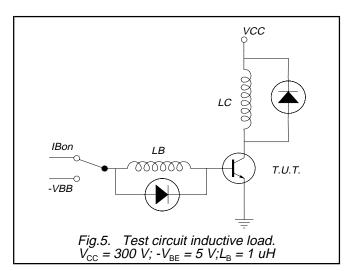
<sup>2</sup> Gain Banding.

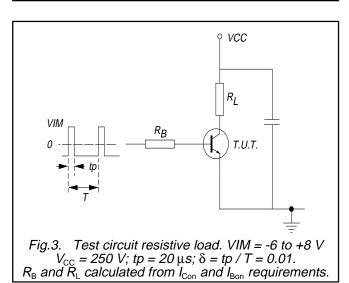
BUT211X

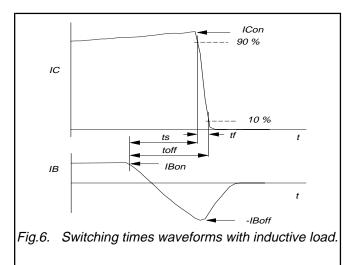




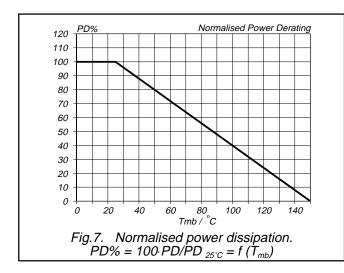


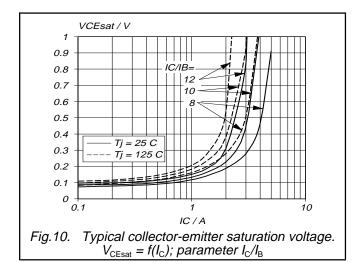


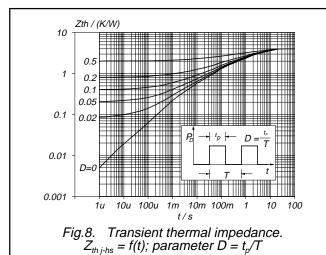


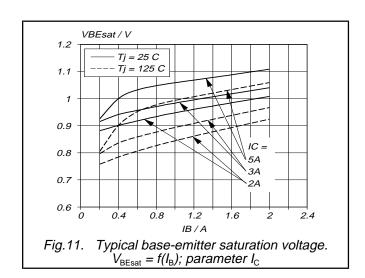


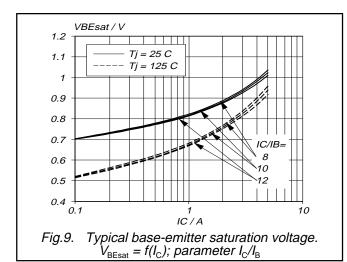
BUT211X

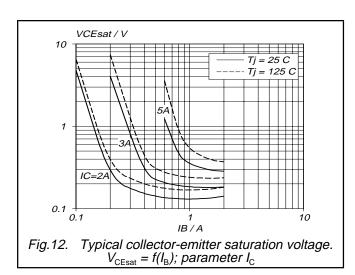




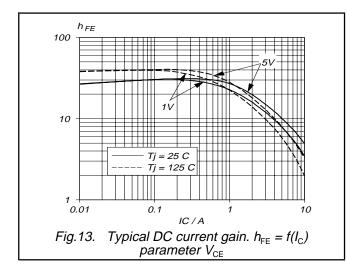


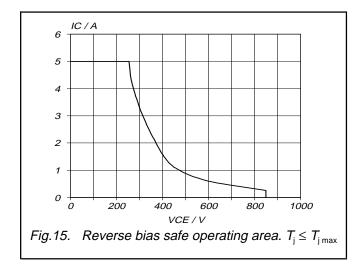


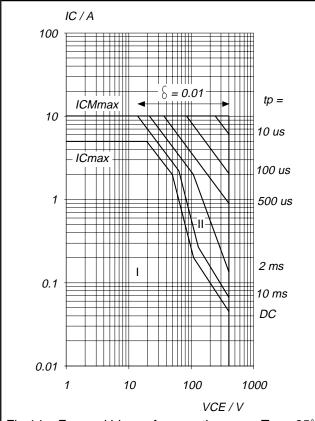




BUT211X







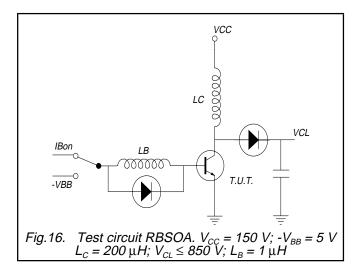
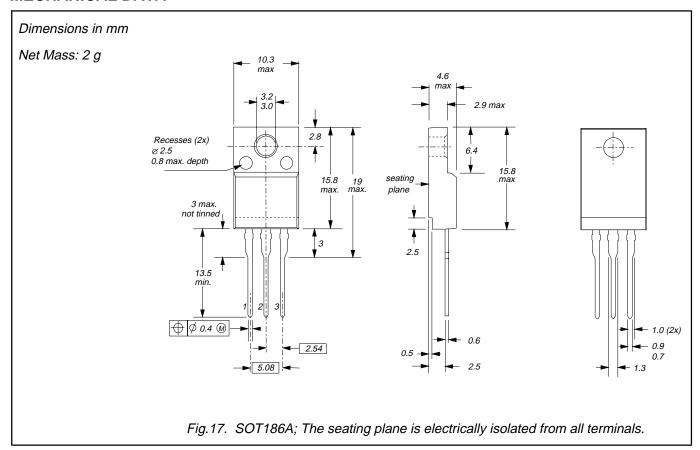


Fig.14. Forward bias safe operating area.  $T_{mb} = 25^{\circ}C$ 

I Region of permissible DC operation. II Extension for repetitive pulse operation. NB: Mounted with heatsink compound and  $30 \pm 5$  newton force on the centre of the envelope.

BUT211X

## **MECHANICAL DATA**



- Refer to mounting instructions for F-pack envelopes.
   Epoxy meets UL94 V0 at 1/8".

Philips Semiconductors Product specification

#### Silicon Diffused Power Transistor

BUT211X

#### **DEFINITIONS**

Data sheet status				
Objective specification	This data sheet contains target or goal specifications for product development.			
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.			
Product specification	This data sheet contains final product specifications.			

#### Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

#### **Application information**

Where application information is given, it is advisory and does not form part of the specification.

#### © Philips Electronics N.V. 1997

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

The information presented in this document does not form part of any quotation or contract, it is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent or other industrial or intellectual property rights.

#### LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.